

TP3076 COMBO® II Programmable PCM CODEC/Filter for ISDN and Digital Phone Applications

General Description

The TP3076 is a second-generation combined PCM CODEC and Filter devices optimized for digital switching applications on subscriber line and trunk cards and digital phone applications. Using advanced switched capacitor techniques, COMBO II combines transmit bandpass and receive lowpass channel filters with a companding PCM encoder and decoder. The devices are A-law and µ-law selectable and employ a conventional serial PCM interface capable of being clocked up to 4.096 MHz. A number of programmable functions may be controlled via a serial control port.

Channel gains are programmable over a 25.4 dB range in each direction.

To enable COMBO II to interface to the SLIC control leads, a number of programmable latches are included; each may be configured as either an input or an output. The TP3076 provides 4 latches.

Features

- Complete CODEC and Filter system including: — Transmit and receive PCM channel filters
	- µ-law or A-law companding coder and decoder
	- $-$ Receive power amplifier drives 300Ω
	- 4.096 MHz serial PCM data (max)
- Programmable functions:
	- Transmit gain: 25.4 dB range, 0.1 dB steps
	- Receive gain: 25.4 dB range, 0.1 dB steps
	- Time-slot assignment; to 64 slots/frame
	- 4 interface latches
	- A or µ-law
	- Analog loopback
	- Digital loopback
- Direct interface to solid-state SLICs
- Standard serial control interface
- 80 mW operating power (typ)
- 1.5 mW standby power (typ)
- Designed for CCITT and LSSGR specifications
- TTL and CMOS compatible digital interfaces **Note:** See also AN-614 COMBO II application guide.

Connection Diagram

See NS Package Number N20A

Pin Descriptions

Functional Description

Pin Descriptions (Continued)

POWER-ON INITIALIZATION

When power is first applied, power-on reset circuitry initializes the COMBO II and puts it into the power-down state. The gain control registers for the transmit and receive gain sections are programmed for no output, the power amp is disabled and the device is in the non-delayed timing mode. The Latch Direction Register (LDR) is pre-set with all IL pins programmed as inputs, placing the SLIC interface pins in a high impedance state. The CO pin is in TRI-STATE condition. Other initial states in the Control Register are indicated in Section 2.0.

The desired modes for all programmable functions may be initialized via the control port prior to a Power-up command.

POWER-DOWN STATE

Following a period of activity in the powered-up state the power-down state may be re-entered by writing any of the control instructions into the serial control port with the "P" bit set to "1" as indicated in *Table 1*. It is recommended that the chip be powered down before writing any additional instructions. In the power-down state, all non-essential circuitry is de-activated and the D_x1 output is in the high impedance TRI-STATE condition.

The data stored in the Gain Control registers, the LDR and ILR, and all control bits remain unchanged in the powerdown state unless changed by writing new data via the serial control port, which remains active. The outputs of the Interface Latches also remain active, maintaining the ability to monitor and control the SLIC.

which is controlled by the contents of the Transmit Gain Register (see Programmable Functions section). An active pre-filter then precedes the 3rd order high-pass and 5th order low-pass switched capacitor filters. The A/D converter has a compressing characteristic according to the standard CCITT A or µ255 coding laws, which must be selected by a control instruction during initialization (see *Table 1* and *[Table](#page-4-0) [2](#page-4-0)*). A precision on-chip voltage reference ensures accurate and highly stable transmission levels. Any offset voltage arising in the gain-set amplifier, the filters or the comparator is canceled by an internal auto-zero circuit.

Each encode cycle begins immediately following the assigned Transmit time-slot. The total signal delay referenced to the start of the time-slot is approximately 165 µs (due to the Transmit Filter) plus 125 µs (due to encoding delay), which totals 290 µs. Data is shifted out on D_x1 during the selected time slot on eight rising edges of BCLK.

DECODER AND RECEIVER FILTER

PCM data is shifted into the Decoder's Receive PCM Register via the D_R1 pin during the selected time-slot on the 8 falling edges of BCLK. The Decoder consists of an expanding DAC with either A or µ255 law decoding characteristic, which is selected by the same control instruction used to select the Encode law during initialization. Following the Decoder is a 5th order low-pass switched capacitor filter with integral Sin x/x correction for the 8 kHz sample and hold. A programmable gain amplifier, which must be set by writing to the Receive Gain Register, is included, and finally a Power Amplifier capable of driving a 300Ω load to ±3.5V, a 600Ω load to $\pm 3.8V$ or a 15 kΩ load to $\pm 4.0V$ at peak overload.

TRANSMIT FILTER AND ENCODER

The Transmit section input, VF_xI , is a high impedance input. No external components are necessary to set the gain. Following this is a programmable gain/attenuation amplifier

TABLE 1. Programmable Register Instructions

Functional Description (Continued)

TABLE 1. Programmable Register Instructions (Continued)

Note 1: Bit 7 of bytes 1 and 2 is always the first bit clocked into or out from the CI or CO pin. X = don't care.

Note 2: "P" is the power-up/down control bit, see Power-up/Down Control section. ("0" = Power Up, "1" = Power Down)

Note 3: Other register address codes are invalid and should not be used.

A decode cycle begins immediately after the assigned receive timeslot, and 10 µs later the Decoder DAC output is updated. The total signal delay is 10 us plus 120 us (filter delay) plus 62.5 μ s (1/2 frame) which gives approximately 190 µs.

PCM INTERFACE

The FS_x and FS_B frame sync inputs determine the beginning of the 8-bit transmit and receive time-slots respectively. They may have any duration from a single cycle of BCLK HIGH to one MCLK period LOW. Two different relationships may be established between the frame sync inputs and the actual time-slots on the PCM busses by setting bit 3 in the Control Register (see *[Table 2](#page-4-0)*). Non-delayed data mode is similar to long-frame timing on the TP3050/60 series of devices (COMBO); time-slots begin nominally coincident with the rising edge of the appropriate FS input. The alternative is to use Delayed Data mode, which is similar to shortframe sync timing on COMBO, in which each FS input must be high at least a half-cycle of BCLK earlier than the timeslot. The Time-Slot Assignment circuit on the device can only be used with Delayed Data timing.

When using Time-Slot Assignment, the beginning of the first time-slot in a frame is identified by the appropriate FS input. The actual transmit and receive time-slots are then determined by the internal Time-Slot Assignment counters.

Transmit and Receive frames and time-slots may be skewed from each other by any number of BCLK cycles. During each assigned Transmit time-slot, the D_x1 output shifts data out from the PCM register on the rising edges of BCLK. TS_x1 also pulls low for the first 71⁄2 bit times of the time-slot to control the TRI-STATE Enable of a backplane line-driver. Serial PCM data is shifted into the D_R1 input during each assigned Receive time-slot on the falling edges of BCLK.

SERIAL CONTROL PORT

Control information and data are written into or read-back from COMBO II via the serial control port consisting of the control clock CCLK, the serial data input, CI, and output, CO, and the Chip Select input, CS. All control instructions require 2 bytes, as listed *[Table 1](#page-2-0)*, with the exception of a single byte power-up/down command. The Byte 1 bits are used as follows: bit 7 specifies power up or power down; bits 6, 5, 4 and 3 specify the register address, bit 2 specifies whether the instruction is read or write; bit 1 specifies a one or two byte instruction; and bit 0 is not used.

To shift control data into COMBO II, CCLK must be pulsed high 8 times while \overline{CS} is low. Data on the CI input is shifted into the serial input register on the falling edge of each CCLK pulse. After all data is shifted in, the contents of the input shift register are decoded, and may indicate that a 2nd byte of control data will follow. This second byte may either be defined by a second byte-wide \overline{CS} pulse or may follow the first contiguously, i.e, it is not mandatory for \overline{CS} to return high between the first and second control bytes. At the end of CCLK8 in the 2nd control byte the data is loaded into the appropriate programmable register. \overline{CS} may remain low continuously when programming successive registers, if desired. However, \overline{CS} must be set high when no data transfers are in progress.

To readback Interface Latch data or status information from COMBO II, the first byte of the appropriate instruction is strobed while CS is low, as defined in *[Table 1](#page-2-0)*. CS must be kept low, or be taken low again for a further 8 CCLK cycles, during which the data is shifted onto the CO pin on the rising edges of CCLK. When \overline{CS} is high the CO pin is in the high-impedance TRI-STATE, enabling the CI and CO pins of many devices to be multiplexed together.

If \overline{CS} returns high during either byte 1 or byte 2 before all eight CCLK pulses of that byte occur, both the bit count and byte count are reset and register contents are not affected. This prevents loss of synchronization in the control interface as well as corruption of register data due to processor interrupt or other problem. When \overline{CS} returns low again, the device will be ready to accept bit 1 of byte 1 of a new instruction.

Programmable Functions

POWER-UP/DOWN CONTROL

Following power-on initialization, power-up and power-down control may be accomplished by writing any of the control instructions listed in *[Table 1](#page-2-0)* into COMBO II with the "P" bit set to "0" for power-up or "1" for power-down. Normally it is recommended that all programmable functions be initially programmed while the device is powered down. Power state control can then be included with the last programming instruction or the separate single-byte instruction. Any of the programmable registers may also be modified while the device is powered-up or down by setting the "P" bit as indicated. When the power-up or down control is entered as a single byte instruction, bit one (1) must be reset to a 0.

When a power-up command is given, all de-activated circuits are activated, but the TRI-STATE PCM output(s), D_x1 will remain in the high impedance state until the second FS_x pulse after power-up.

Programmable Functions (Continued)

CONTROL REGISTER INSTRUCTION

The first byte of a READ or WRITE instruction to the Control Register is as shown in *[Table 1](#page-2-0)*. The second byte has the following bit functions:

TABLE 2. Control Register Byte 2 Functions

Note 4: state at power-on initialization.

Master Clock Frequency Selection

A Master clock must be provided to COMBO II for operation of the filter and coding/decoding functions. The MCLK frequency must be either 512 kHz, 1.536 MHz, 1.544 MHz, 2.048 MHz, or 4.096 MHz and must be synchronous with BCLK. Bits F_1 and F_0 (see *Table 2*) must be set during initialization to select the correct internal divider.

Coding Law Selection

Bits "MA" and "IA" in *Table 2* permit the selection of µ255 coding or A-law coding, with or without even bit inversion.

Analog Loopback

Analog Loopback mode is entered by setting the "AL" and "DL" bits in the Control Register as shown in *Table 2*. In the analog loopback mode, the Transmit input VF_xI is isolated from the input pin and internally connected to the VF_RO output, forming a loop from the Receive PCM Register back to the Transmit PCM Register. The VF_BO pin remains active, and the programmed settings of the Transmit and Receive gains remain unchanged, thus care must be taken to ensure that overload levels are not exceeded anywhere in the loop.

Digital Loopback

Digital Loopback mode is entered by setting the "AL" and "DL" bits in the Control Register as shown in *Table 2*. This mode provides another stage of path verification by enabling data written into the Receive PCM Register to be read back from that register in any Transmit time-slot at $D_x 1$. PCM decoding continues and analog output appears at VF_B0 . The output can be disabled by programming 'No Output' in the Receive Gain Register (see *[Table 8](#page-6-0)*).

INTERFACE LATCH DIRECTIONS

Immediately following power-on, all Interface Latches assume they are inputs, and therefore all IL pins are in a high impedance state. Each IL pin may be individually programmed as a logic input or output by writing the appropriate instruction to the LDR, see *[Table 1](#page-2-0)* and *Table 3*. For minimum power dissipation, unconnected latch pins should be programmed as outputs. For the TP3076, bits 2 and 3 should always be programmed as "1" (outputs).

Bits L_3-L_0 must be set by writing the specific instruction to the LDR with the L bits in the second byte set as follows:

X = Don't Care

INTERFACE LATCH STATES

Interface Latches configured as outputs assume the state determined by the appropriate data bit in the 2-byte instruction written to the Interface Latch Register (ILR) as shown in *[Table 1](#page-2-0)* and *Table 4*. Latches configured as inputs will sense the state applied by an external source, such as the Off-Hook detect output of a SLIC. All bits of the ILR, i.e. sensed inputs and the programmed state of outputs, can be read back in the 2nd byte of a READ from the ILR.

It is recommended that during initialization, the state of IL pins to be configured as outputs should be programmed first followed immediately by the Latch Direction Register.

TABLE 4. Interface Latch Data Bit Order

Programmable Functions (Continued)

Note 5: The MSB is always the first PCM bit shifted in or out of COMBO II.

TABLE 6. Time-Slot and Port Assignment Instruction

Note 6: The "PS" bit MUST be set to "1" for both transmit and receive for the TP3076.

Note 7: T5 is the MSB of the time-slot assignment bit field. Time-slot bits should be set to "000000" for both transmit and receive when operating in non-delayed data timing mode.

TIME-SLOT ASSIGNMENT

COMBO II can operate in either fixed time-slot or time-slot assignment mode for selecting the Transmit and Receive PCM time-slots. Following power-on, the device is automatically in Non-Delayed Timing mode, in which the time-slot always begins with the leading (rising) edge of frame sync inputs FS_x and FS_R . Time-Slot Assignment may only be used with Delay Data timing; see [Figure 3](#page-11-0). FS_x and FS_R may have any phase relationship with each other in BCLK period increments.

Alternatively, the internal time-slot assignment counters and comparators can be used to access any time-slot in a frame, using the frame sync inputs as marker pulses for the beginning of transmit and receive time-slot 0. In this mode, a frame may consist of up to 64 time-slots of 8 bits each. A time-slot is assigned by a 2-byte instruction as shown in *[Table 1](#page-2-0)* and *Table 6*. The last 6 bits of the second byte indicate the selected time-slot from 0–63 using straight binary notation. When writing a time-slot and port assignment register, if the PCM interface is currently active, it is immediately deactivated to prevent possible bus clashes. A new assignment becomes active on the second frame following the end of the Chip-Select for the second control byte. Rewriting of the register contents should not be performed during the talking period of a connection to prevent waveform distortion caused by loss of a sample which will occur with each register write. The "EN" bit allows the PCM input, D_R 1, or output, D_X 1, as appropriate, to be enabled or disabled.

Time-Slot Assignment mode requires that the FS_x and FS_B pulses conform to the delayed data timing format shown in *[Figure 3](#page-11-0)*.

PORT SELECTION

On the TP3076, the "PS" bit MUST always be set to 1.

Table 6 shows the format for the second byte of both transmit and receive time-slot and port assignment instructions.

TRANSMIT GAIN INSTRUCTION BYTE 2

The transmit gain can be programmed in 0.1 dB steps by writing to the Transmit Gain Register as defined in *[Table 1](#page-2-0)* and *Table 7*. This corresponds to a range of 0 dBm0 levels at VF_xI between 1.375 Vrms and 0.074 Vrms (equivalent to +5.0 dBm to −20.4 dBm in 600Ω).

To calculate the binary code for byte 2 of this instruction for any desired input 0 dBm0 level in Vrms, take the nearest integer to the decimal number given by:

200 x log_{10} (V/0.07299)

and convert to the binary equivalent. Some examples are given in *Table 7*. A complete tabulation is given in Appendix I of AN-614.

It should be noted that the Transmit (idle channel) Noise and Transmit Signal to Total Distortion are both specified with transmit gain set to 0 dB (gain register set to all ones). At high transmit gains there will be some degradation in noise performance for these parameters. See Application Note AN-614 for more information on this subject.

TABLE 7. Byte 2 of Transmit Gain Instruction

Programmable Functions (Continued)

TABLE 7. Byte 2 of Transmit Gain Instruction (Continued)

Note 8: Analog signal path is cut off, but D_X remains active and will output codes representing idle noise.

RECEIVE GAIN INSTRUCTION BYTE 2

The receive gain can be programmed in 0.1 dB steps by writing to the Receive Gain Register as defined in *[Table 1](#page-2-0)* and *Table 8*. Note the following restrictions on output drive capability:

- 1. 0 dBm0 levels \leq 1.96 Vrms at VF_RO may be driven into a load of \geq 15 kΩ to GND; Receive Gain set to 0 dB (gain register set to all ones).
- 2. 0 dBm0 levels \leq 1.85 Vrms at VF_RO may be driven into a load of $\geq 600\Omega$ to GND; Receive Gain set to 0.5 dB.
- 3. 0 dBm0 levels \leq 1.71 Vrms at VF_BO may be driven into a load of ≥ 300 Ω to GND. Receive Gain set to −1.2 dB.

To calculate the binary code for byte 2 of this instruction for any desired output 0 dBm0 level in Vrms, take the nearest integer to the decimal number given by:

200 x log_{10} (V/0.1043)

and convert to the binary equivalent. Some examples are given in *Table 8*. A complete tabulation is given in Appendix I or AN-614.

TABLE 8. Byte 2 of Receive Gain Instruction

Applications Information

[Figure 1](#page-7-0) shows a typical ISDN phone application of the TP3076 together with a TP3420 ISDN Transceiver "S" Interface Device and HPC16400 High-Performance Microcontroller with HDLC Controller. The TP3076 device is programmed over its serial control interface via the HPC16400 MICROWIRE/PLUS™ serial I/O port.

POWER SUPPLIES

While the pins of the TP3076 COMBO II device are well protected against electrical misuse, it is recommended that the standard CMOS practice of applying GND to the device before any other connections are made should always be followed. In applications where the printed circuit card may be plugged into a hot socket with power and clocks already present, an extra long ground pin on the connector should be used and a Schottky diode connected between V_{BB} and GND.

To minimize noise sources all ground connections to each device should meet at a common point as close as possible to the GND pin in order to prevent the interaction of ground return currents flowing through a common bus impedance. Power supply decoupling capacitors of 0.1 µF should be connected from this common point to V_{CC} and V_{BB} as close to the device pins as possible.

Further guidelines on PCB layout techniques are provided in Application Note AN-614, "COMBO II™ Programmable PCM CODEC/Filter Family Application Guide".

Absolute Maximum Ratings [\(Note 12\)](#page-9-0)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Electrical Characteristics

Unless otherwise noted, limits printed in **BOLD** characters are guaranteed for V_{CC} = +5V ±5%, V_{BB} = -5V ±5%; T_A = 0°C to +70°C by correlation with 100% electrical testing at $T_A = 25$ °C. All other limits are assured by correlation with other production tests and/or product design and characterization. All signals referenced to GND. Typicals specified at V_{CC} = +5V, V_{BB} = -5V, $T_A = 25^{\circ}C$.

Electrical Characteristics (Continued)

Note 12: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits.

Note 13: See definitions and timing conventions section.

Timing Specifications

Unless otherwise noted, limits printed in **BOLD** characters are guaranteed for V_{CC} = +5V ±5%; V_{BB} = -5V ±5%; T_A = 0°C to +70°C by correlation with 100% electrical testing at $T_A = 25^\circ$ C. All other limits are assured by correlation with other production tests and/or product design and characterization. All signals referenced to GND. Typicals specified at V_{CC} = +5V, V_{BB} = -5V, $T_A = 25^{\circ}$ C. All timing parameters are measured at $V_{OH} = 2.0V$ and $V_{OL} = 0.7V$. See Definitions and Timing Conventions section for test methods information.

Timing Specifications (Continued)

Unless otherwise noted, limits printed in **BOLD** characters are guaranteed for V_{CC} = +5V ±5%; V_{BB} = −5V ±5%; T_A = 0°C to +70°C by correlation with 100% electrical testing at T_A = 25°C. All other limits are assured by correlation with other production tests and/or product design and characterization. All signals referenced to GND. Typicals specified at V $_{\rm CC}$ = +5V, V $_{\rm BB}$ = –5V, T_A = 25°C. All timing parameters are measured at V_{OH} = 2.0V and V_{OL} = 0.7V. See Definitions and Timing Conventions section for test methods information.

Note 14: Applies only to MCLK Frequencies ≥ 1.536 MHz. At 512 kHz a 50:50 ±2% Duty Cycle must be used.

Timing Diagrams

TP3076

FIGURE 3. Delayed Data Timing Mode

Transmission Characteristics

Unless otherwise noted, limits printed in **BOLD** characters are guaranteed for V_{CC} = +5V ±5%, V_{BB} = −5V ±5%; T_A = 0°C to +70°C by correlation with 100% electrical testing at T_A = 25°C. f = 1015.625 Hz, VF_XI = 0 dBm0, D_R1 = 0 dBm0 PCM code. Transmit and receive gains programmed for maximum 0 dBm0 test levels (0 dB Gain). All other limits are assured by correlation with other production tests and/or product design and characterization. All signals referenced to GND. Typicals specified at V_{CC} = +5V, V_{BB} = -5V, T_A = 25[°]C.

Transmission Characteristics (Continued)

Unless otherwise noted, limits printed in **BOLD** characters are guaranteed for V_{CC} = +5V ±5%, V_{BB} = −5V ±5%; T_A = 0°C to +70°C by correlation with 100% electrical testing at T_A = 25°C. f = 1015.625 Hz, VF_XI = 0 dBm0, D_R1 = 0 dBm0 PCM code. Transmit and receive gains programmed for maximum 0 dBm0 test levels (0 dB Gain). All other limits are assured by correlation with other production tests and/or product design and characterization. All signals referenced to GND. Typicals specified at V_{CC} = +5V, V_{BB} = -5V, T_A = 25°C.

Transmission Characteristics (Continued)

Unless otherwise noted, limits printed in **BOLD** characters are guaranteed for V_{CC} = +5V ±5%, V_{BB} = −5V ±5%; T_A = 0°C to +70°C by correlation with 100% electrical testing at T_A = 25°C. f = 1015.625 Hz, VF_XI = 0 dBm0, D_R1 = 0 dBm0 PCM code. Transmit and receive gains programmed for maximum 0 dBm0 test levels (0 dB Gain). All other limits are assured by correlation with other production tests and/or product design and characterization. All signals referenced to GND. Typicals specified at V_{CC} = +5V, V_{BB} = -5V, T_A = 25°C.

Transmission Characteristics (Continued)

Unless otherwise noted, limits printed in **BOLD** characters are guaranteed for V_{CC} = +5V ±5%, V_{BB} = -5V ±5%; T_A = 0°C to +70°C by correlation with 100% electrical testing at $T_A = 25^\circ$ C. $f = 1015.625$ Hz, $VF_xI = 0$ dBm0, $\overline{D}_R1 = 0$ dBm0 PCM code. Transmit and receive gains programmed for maximum 0 dBm0 test levels (0 dB Gain). All other limits are assured by correlation with other production tests and/or product design and characterization. All signals referenced to GND. Typicals specified at V_{CC} = +5V, V_{BB} = -5V, T_A = 25°C.

Note 15: Measured by grounded input at V_{FXI} .

Note 16: PPSR_X, NPSR_X, and CT_{R-X} are measured with a -50 dBm0 activation signal applied to VF_XI.

Note 17: A signal is Valid if it is above V_{IH}or below V_{IL} and Invalid if it is between V_{IL} and V_{IH}. For the purposes of this specification the following conditions apply: a) All input signals are defined as: $V_{\parallel L} = 0.4V$, $V_{\parallel H} = 2.7V$, $t_{\text{R}} < 10$ ns, $t_{\text{F}} < 10$ ns.

b) t_R is measured from V_{IL} to V_{IH} . t_F is measured from V_{IH} to V_{IL} .

c) Delay Times are measured from the input signal Valid to the output signal Valid.

d) Setup Times are measured from the data input Valid to the clock input Invalid.

e) Hold Times are measured from the clock signal Valid to the data input Invalid.

f) Pulse widths are measured from $V_{\vert L}$ to $V_{\vert L}$ or from $V_{\vert H}$ to $V_{\vert H}$.

Note 18: A multi-tone test technique is used.

